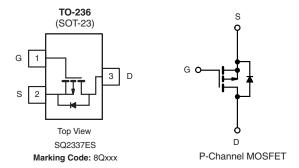


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Vishay Siliconix

Automotive P-Channel 80 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 80			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.290			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -6 \text{ V}$	0.314			
I _D (A)	- 2.2			



FEATURES

- TrenchFET® Power MOSFET
- AEC-Q101 Qualified^c
- 100 % R_q and UIS Tested
- Material categorization:
 For definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE

ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and Halogen-free	SQ2337ES-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T	_C = 25 °C, unles	s otherwise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	- 80	V	
Gate-Source Voltage		V_{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C	1	- 2.2		
Continuous Drain Current	T _C = 125 °C	I _D	- 1.3		
Continuous Source Current (Diode Conduction)		I _S	- 3.7	Α	
Pulsed Drain Current ^a		I _{DM}	- 9		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 11		
Single Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	6	mJ	
Maximum Dower Dissinations	T _C = 25 °C	P _D	3	W	
Maximum Power Dissipation ^a	T _C = 125 °C] FD	1	VV	
Operating Junction and Storage Temperature Ra	nge	T _J , T _{stg}	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^b	R_{thJA}	166	°C/W
Junction-to-Foot (Drain)		R_{thJF}	50	C/VV

Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. When mounted on 1" square PCB (FR-4 material).
- c. Parametric verification ongoing.



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					ı		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0, I _D = - 250 μA	- 80	-	-	.,
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 1.5	-	- 2.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
		V _{GS} = 0 V	V _{DS} = - 80 V	-	-	- 1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = - 80 V, T _J = 125 °C	-	-	- 50	μΑ
		V _{GS} = 0 V	V _{DS} = - 80 V, T _J = 175 °C	-	-	- 150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V	$V_{DS} \ge 5 V$	- 8	-	-	Α
Data October Designation	В	V _{GS} = - 10 V	I _D = - 1.2 A	-	0.241	0.290	V nA μA
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 6 V	I _D = - 1.1 A	-	0.261	0.314	
Forward Transconductance ^b	9fs	V _{DS} =	- 15 V, I _D = - 1.2 A	-	3.5	-	S
Dynamic ^b							
Input Capacitance	C _{iss}			-	495	620	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = -40 \text{ V, f} = 1 \text{ MHz}$	-	40	55	рF
Reverse Transfer Capacitance	C _{rss}			-	30	38	
Total Gate Charge ^c	Qg			-	11.5	18	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = - 10 V	V _{DS} = - 40 V, I _D = - 1.2 A	-	1.9	-	V .5 V .00 nA 1
Gate-Drain Charge ^c	Q_{gd}			-	3.3	-	
Gate Resistance	R _g		f = 1 MHz	2.2	4.43	7	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	5	8	
Rise Time ^c	t _r	$V_{DD} = 0$	- 40 V, $R_L = 41.6 \Omega$	-	10	15	no
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -0.96 \text{ A, V}_{GEN} = -10 \text{ V, R}_g = 1 \Omega$		27	7		
Fall Time ^c	t _f			-	8	12	
Source-Drain Diode Ratings and Chara	acteristics ^b						
Pulsed Current ^a	I _{SM}			ı	-	- 9	Α
Forward Voltage	V _{SD}	l _F =	- 0.8 A, V _{GS} = 0	-	- 0.8	- 1.2	V

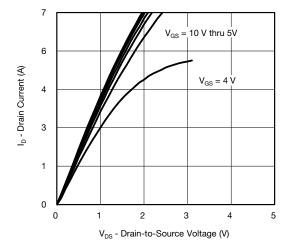
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

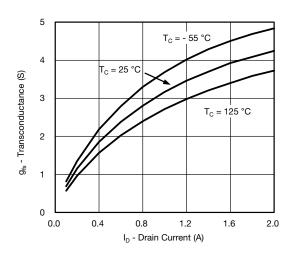
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



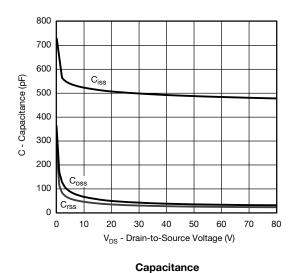
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

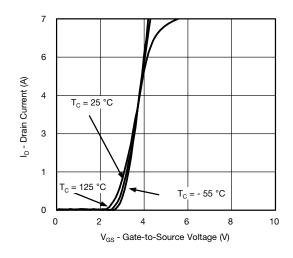


Output Characteristics

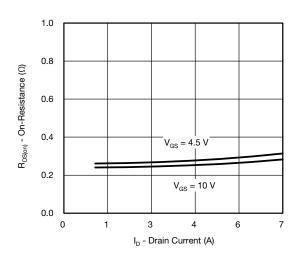


Transconductance

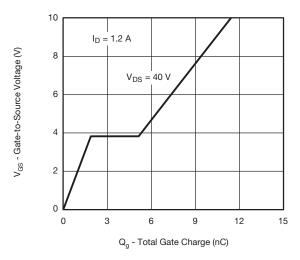




Transfer Characteristics

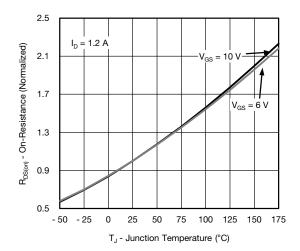


On-Resistance vs. Drain Current

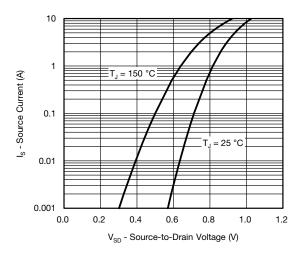




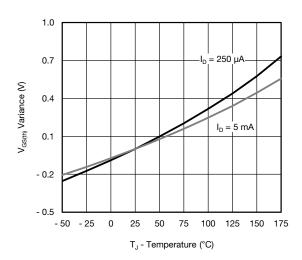
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



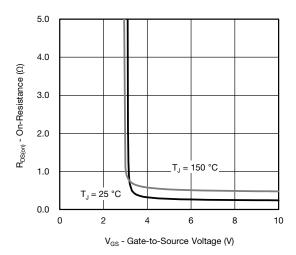
On-Resistance vs. Junction Temperature



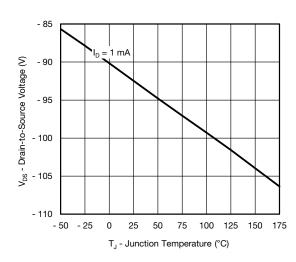
Source-Drain Diode Forward Voltage



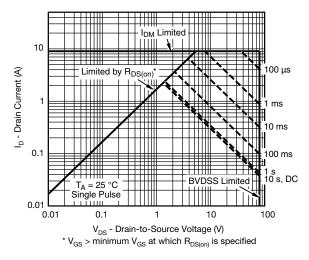
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



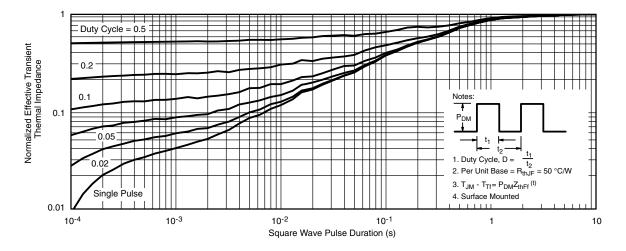
Drain Source Breakdown vs. Junction Temperature



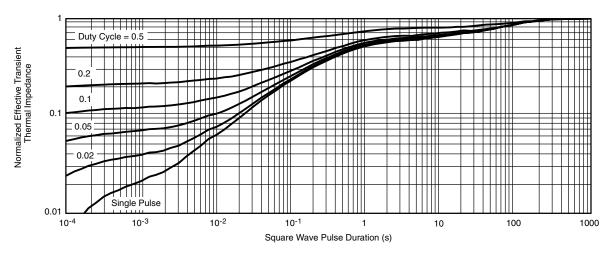
Safe Operating Area



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot



Normalized Thermal Transient Impedance, Junction-to-Ambient

Note

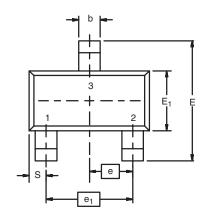
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

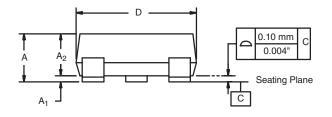
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

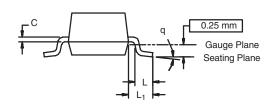
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SOT-23 (TO-236): 3-LEAD







Dim —	MILLIN	IETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025	i Ref	
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	

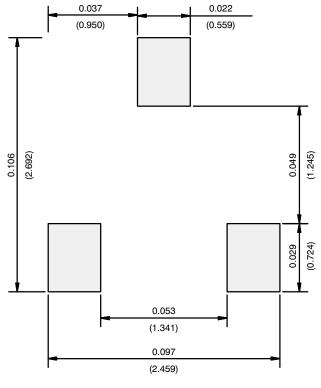
ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01 1



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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